Contents

Preface *XV*
List of Contributors *XVII*

Part I Powders *1*

1 Powder Compaction by Dry Pressing *3*
Rainer Oberacker
1.1 Introduction *3*
1.2 Fundamental Aspects of Dry Pressing *3*
1.2.1 Die or Mold Filling Behavior of Powders *4*
1.2.1.1 Particle Packing: A Static View *5*
1.2.1.2 Practical Aspects of Die Filling With Granulates *7*
1.2.2 Compaction Behavior *8*
1.2.2.1 Compaction of Monolithic Powders *8*
1.2.2.2 Compaction of Granulated Powders *10*
1.2.2.3 Understanding Powder Compaction by Advanced Modeling *14*
1.3 Practice of Uniaxial Compaction *19*
1.3.1 Die Filling *19*
1.3.2 Tooling Principles and Pressing Tools *21*
1.3.3 Powder Compaction Presses *23*
1.4 Practice of Isostatic Compaction *25*
1.4.1 Wet-Bag Isostatic Pressing *25*
1.4.2 Dry-Bag Isostatic Pressing *28*
1.5 Granulation of Ceramic Powders *29*
1.5.1 Spray-Drying *30*
1.5.2 Alternative Spray Granulation Methods *33*
1.5.3 Characterization of Ceramic Granulates *34*
References *34*

2 Tape Casting *39*
Andreas Roosen
2.1 Use of the Tape Casting Process *39*
2.2 Process Variations *41*

2.3 Tape Casting Process *42*
2.4 Components of the Slurry *44*
2.4.1 Inorganic Raw Materials *45*
2.4.2 Solvents *46*
2.4.3 Organic Raw Materials *47*
2.4.3.1 Dispersing Agents *47*
2.4.3.2 Binder and Plasticizer *48*
2.4.3.3 Other Additives *49*
2.4.4 Interaction between Slurry Components *50*
2.5 Preparation of the Slurry and its Properties *51*
2.6 Tape Casting *52*
2.6.1 Drying and Characteristics of the Green Tape *54*
2.7 Machining, Metallization, and Lamination *55*
2.8 Binder Burnout *56*
2.9 Firing *56*
2.10 Summary *58*
References *58*

3 Hydrothermal Routes to Advanced Ceramic Powders and Materials *63*
Wojciech L. Suchanek and Richard E. Riman
3.1 Introduction to Hydrothermal Synthesis *63*
3.1.1 Fundamental Definitions *63*
3.1.2 Process Development and Industrial Production *65*
3.1.3 Hydrothermal Hybrid Techniques *67*
3.1.4 Physical and Chemical Advantages of Hydrothermal Solutions *68*
3.2 Engineering Ceramic Synthesis in Hydrothermal Solution *69*
3.2.1 Phase Partitioning in Hydrothermal Systems *69*
3.2.2 A Rational Approach for Engineering Hydrothermal Synthesis Methods *69*
3.2.3 Thermodynamic Modeling *70*
3.2.4 Examples of Synthesis Engineering *72*
3.3 Materials Chemistry of Hydrothermal Ceramic Powders *74*
3.3.1 Control of Chemical Composition *74*
3.3.2 Physical Characteristics and their Control *77*
3.4 Ceramics Processed from Hydrothermally Synthesized Powders *80*
3.4.1 Synthesis of Modified Powders for Enhanced Sinterability *80*
3.4.2 Powders for Sintered Dense Ceramics with Fine Grain Size *81*
3.4.3 Sintered Porous Ceramics from Hydrothermally Synthesized Powders *85*
3.4.4 Fabrication of Textured Ceramics from Hydrothermal Powders *86*
3.4.5 *In-Situ* Hydrothermal Conversion and Hydrothermal Sintering *87*
3.5 Summary *88*
References *88*

4 Liquid Feed-Flame Spray Pyrolysis (LF-FSP) in the Synthesis of Single- and Mixed-Metal Oxide Nanopowders *97*
Richard M. Laine
4.1 Introduction *97*
4.2 Basic Concepts of Nanopowder Formation During LF-FSP *100*
4.2.1 Particle Size Distributions *101*
4.2.2 Phase Formation *102*
4.2.3 Phase Characterization *103*
4.3 Can Nanoparticles Be Prepared That Consist of Mixed Phases? *104*
4.3.1 The TiO_2/Al_2O_3 System *104*
4.3.2 Changing Band Gaps *107*
4.4 Which Particle Morphologies Can be Accessed? *107*
4.5 Can Nanopowders Be Doped? *110*
4.5.1 Sinter-Resistant Materials *110*
4.5.2 Laser Paints *111*
References *116*

5 Sol–Gel Processing of Ceramics *121*
Nicola Hüsing
5.1 Introduction *121*
5.2 Principles of Sol–Gel Processing *122*
5.3 Porous Materials *126*
5.4 Hybrid Materials *130*
5.5 Bioactive Sol–Gel Materials *133*
5.5.1 *In-Situ* Encapsulation of Biomolecules *133*
5.5.2 Bioactive Materials *136*
References *137*

Part II Densification and Beyond *141*

6 Sintering *143*
Suk-Joong L. Kang
6.1 Sintering Phenomena *143*
6.2 Solid-State Sintering *144*
6.2.1 Sintering Models and Kinetics with No Grain Growth *144*
6.2.1.1 Initial Stage Model and Kinetics *145*
6.2.1.2 Intermediate and Final Stage Models and Kinetics *148*
6.2.1.3 Grain Boundary Structure and Densification Kinetics *150*
6.2.2 Grain Growth *150*
6.2.2.1 Normal Grain Growth *151*
6.2.2.2 Grain Growth in the Presence of Second-Phase Particles *152*
6.2.2.3 Grain Growth with Boundary Segregation *152*
6.2.2.4 Grain Growth Behavior with Boundary Structure *154*
6.2.3 Microstructure Development *155*
6.3 Liquid-Phase Sintering *156*

6.3.1 Densification Models and Theories *157*
6.3.1.1 Contact Flattening *159*
6.3.1.2 Pore Filling *159*
6.3.2 Grain Growth *161*
6.3.3 Microstructure Development *163*
6.4 Summary *164*
References *165*

7 Hot Isostatic Pressing and Gas-Pressure Sintering *171*
Michael J. Hoffmann, Stefan Fünfschilling, and Deniz Kahraman
7.1 Introduction *171*
7.2 Sintering Mechanisms with Applied Pressure *172*
7.3 Silicon Nitride Ceramics: Comparison of Capsule HIP and Sinter-HIP Technology *175*
7.3.1 Capsule HIP *176*
7.3.2 Sinter-HIP *177*
7.3.3 Differences between Capsule-HIP and Sinter-HIP *181*
7.4 Other Applications *182*
7.4.1 Structural Ceramics *182*
7.4.2 Post-HIPing of Oxide Ceramics for Optical Applications *182*
References *185*

8 Hot Pressing and Spark Plasma Sintering *189*
Mats Nygren and Zhijian Shen
8.1 Introduction *189*
8.2 Advantages of Sintering Under a Uniaxial Pressure *190*
8.3 Conventional Hot Presses *193*
8.4 SPS Set-Up *194*
8.5 Unique Features and Advantages of the SPS Process *196*
8.6 The Role of High Pressure *197*
8.7 The Role of Rapid and Effective Heating *199*
8.8 The Role of Pulsed Direct Current *202*
8.9 Microstructural Prototyping by SPS *203*
8.9.1 Nanoceramics and Ceramics Nanocomposites *203*
8.9.2 Self-Reinforced Ceramics *205*
8.9.3 Superplasticity and Textured Ceramics *206*
8.9.4 Non-Equilibrium Ceramic Composites *208*
8.9.5 Ceramics with Macro- and Micro- Graded Structures *210*
8.9.6 Hard-to-Make Ceramics *211*
8.9.7 Defect-Engineered Ceramics *212*
8.10 Potential Industrial Applications *213*
References *213*

9 Fundamentals and Methods of Ceramic Joining *215*
K. Scott Weil
9.1 Introduction *215*
9.2 Basic Phenomena in Ceramic Joining *216*
9.2.1 Mechanics *216*
9.2.1.1 The Strength of Ceramics *216*
9.2.1.2 Contact Stress *217*
9.2.1.3 Residual Stress *217*
9.2.1.4 Elastic Modulus Effects *219*
9.2.1.5 Other Effects *220*
9.2.1.6 Strength of Bonded Joints *220*
9.2.2 Adhesion and Wetting *221*
9.2.3 Diffusion *224*
9.2.4 Chemical Reaction *225*
9.3 Methods of Joining *227*
9.3.1 Mechanical Joining *227*
9.3.2 Direct Bonding *231*
9.3.2.1 Solid-State Direct-Bonding Processes *231*
9.3.2.2 Liquid-State Direct-Bonding Processes *234*
9.3.3 Interlayer Bonding *235*
9.3.3.1 Solid-State Interlayer Bonding Processes *235*
9.3.3.2 Liquid-State Interlayer Bonding Processes *237*
9.4 Conclusions *243*
References *243*

10 Machining and Finishing of Ceramics *247*
Eckart Uhlmann, Gregor Hasper, Thomas Hoghé, Christoph Hübert, Vanja Mihotovic, and Christoph Sammler
10.1 Introduction *247*
10.2 Face and Profile Grinding *248*
10.2.1 Process Description *248*
10.2.2 Machining of Ceramics *250*
10.3 Current Status and Future Prospects *251*
10.4 Double-Face Grinding with Planetary Kinematics *252*
10.4.1 Process Description *252*
10.4.2 Machining of Ceramics *254*
10.4.3 Current Status and Future Prospects *255*
10.5 Ultrasonic-Assisted Grinding *256*
10.5.1 Process Description *256*
10.5.2 Machining of Ceramics *256*
10.5.3 Current Status and Future Prospects *258*
10.6 Abrasive Flow Machining *261*
10.6.1 Process Description *261*
10.6.2 Machining of Ceramics *263*

10.6.3 Current Status and Future Prospects *263*
10.7 Outlook *264*
References *265*

Part III Films and Coatings *267*

11 Vapor-Phase Deposition of Oxides *269*
Lambert Alff, Andreas Klein, Philipp Komissinskiy, and Jose Kurian
11.1 Introduction *269*
11.1.1 Sputter Deposition *270*
11.1.2 Pulsed-Laser Deposition *275*
11.1.3 Oxide Molecular Beam Epitaxy *282*
11.2 Summary *289*
References *289*

12 Metal–Organic Chemical Vapor Deposition of Metal Oxide Films and Nanostructures *291*
Sanjay Mathur, Aadesh Pratap Singh, Ralf Müller, Tessa Leuning, Thomas Lehnen, and Hao Shen
12.1 Introduction *291*
12.2 Metal Oxide Film Deposition *300*
12.2.1 Physical and Chemical Vapor Deposition Techniques *300*
12.2.2 Chemical Vapor Deposition *302*
12.2.2.1 Thermally Activated CVD (TA-CVD) *302*
12.2.2.2 Plasma-Enhanced CVD (PE-CVD) *303*
12.2.2.3 Molecule-Based CVD (MB-CVD) *304*
12.2.3 Atomic Layer Deposition *304*
12.2.4 Growth Dynamics *308*
12.2.4.1 Amorphous Growth *309*
12.2.4.2 Epitaxial Growth *309*
12.2.4.3 Polycrystalline Growth *309*
12.2.5 Mechanistic Aspects of CVD *310*
12.3 The Precursor Concept in CVD *313*
12.3.1 Precursor Requisites *313*
12.3.2 Precursor–Material Relationship *314*
12.3.3 Influence of Precursor Flow Rate on Microstructure and Growth *320*
12.4 Metal Oxide Coatings *321*
12.4.1 Monometallic Precursor (MO_x) Systems *321*
12.4.2 Bimetallic Precursor (MM'Ox) Systems *324*
12.4.3 Composites (MO_x/M'O_y) Systems *326*
12.5 Summary *327*
References *330*

Part IV Manufacturing Technology *337*

13 Powder Characterization *339*
Wolfgang Sigmund, Vasana Maneeratana, and Shu-Hau Hsu
13.1 Introduction *339*
13.1.1 Accuracy Versus Precision and Instrument Resolution *340*
13.1.2 Sampling *341*
13.2 Chemical Composition and Surface Characterization *343*
13.2.1 Bulk Elemental Identification *344*
13.2.1.1 Optical Absorption Spectroscopy *344*
13.2.1.2 Electron and X-Ray Microanalysis *346*
13.2.1.3 Infrared Spectroscopy *347*
13.2.1.4 Raman Spectroscopy *348*
13.2.1.5 Nuclear Magnetic Resonance Spectroscopy *348*
13.2.1.6 Detailed Depth Profiling of Elemental Distribution within a Particle *348*
13.2.2 Surface Characterization *349*
13.2.2.1 Surface Chemistry Analysis *349*
13.2.2.2 Vacuum Techniques *350*
13.2.2.3 Specific Surface Area of Particles *351*
13.2.2.4 Electrokinetic Potential or Zeta-Potential *353*
13.2.3 Crystallographic Identification *353*
13.3 Particle Sizing and Data Interpretation *354*
13.3.1 Particles Types *354*
13.3.2 Particle Shapes *355*
13.3.3 General Methods *356*
13.3.4 Light Scattering Techniques *357*
13.3.5 Sedimentation Analysis *358*
13.3.6 Coulter Counter *360*
13.3.7 Image-Based Analysis *361*
13.3.8 Sieve Analysis *362*
13.3.8.1 Dry Sieving *363*
13.3.8.2 Wet Sieving *363*
13.4 Physical Properties *363*
13.4.1 Particle Density *363*
13.4.1.1 Particle Density Definition *364*
13.4.1.2 Particle Density Measurement *365*
13.4.2 Powder Porosity *366*
13.5 Summary *367*
References *367*

14 Process Defects *369*
Keizo Uematsu
14.1 Introduction *369*
14.2 Bulk Examination Methods *370*

14.3 Characterization Methods for Green Compact *371*
14.3.1 Specimen Preparation *371*
14.3.1.1 Ceramics *371*
14.3.1.2 Green Compact *371*
14.3.2 Observation with an Optical Microscope *373*
14.3.2.1 Transmission Optical Microscopy *373*
14.3.2.2 Polarized Light Microscopy *373*
14.3.2.3 Infrared Transmission Microscopy *374*
14.3.2.4 Confocal Fluorescent Scanning Laser Microscopy (CFSLM) *374*
14.4 Process Defects in Ceramics *375*
14.4.1 Short-Range Defects *375*
14.4.1.1 Circumferential Cracks at the Granular Boundaries *377*
14.4.1.2 Dimple Defects at the Centers of Granules *378*
14.4.1.3 Coarse Particles/Aggregates *381*
14.4.1.4 Defects Due to Inhomogeneous Distribution of Binder *383*
14.4.2 Long-Range Defects *387*
14.4.2.1 Particle Size Variation *387*
14.4.2.2 Density Variation *387*
14.4.2.3 Orientation of Particles *388*
14.4.2.4 Anisotropic Packing *392*
14.4.2.5 Long-Range Distribution of Additives *392*
References *393*

15 Nonconventional Polymers in Ceramic Processing: Thermoplastics and Monomers *395*
John W. Halloran
15.1 Introduction: Ceramic Green Bodies as Filled Polymers *395*
15.2 Thermoplastics in Ceramic Processing *396*
15.3 A Brief Review of Thermoplastics Used in Ceramic Forming *397*
15.4 Melt Spinning of Fibers *397*
15.5 Single-Component Extrusion and "Plastics Processing" *398*
15.6 Thermoplastic Green Machining *400*
15.7 Thermoplastic Coextrusion *401*
15.8 Crystallinity in Thermoplastics *403*
15.9 Compounding Thermoplastic Blends *404*
15.10 Volumetric Changes in Thermoplastic–Ceramic Compounds *405*
15.11 Polymer Formation by Polymerization of Suspensions in Monomers *407*
15.12 Summary *410*
References *411*

16 Manufacturing Technology: Rapid Prototyping *415*
James D. McGuffin-Cawley
16.1 Introduction *415*
16.2 Outline of Ceramic Processing *418*

16.3 Solid Freeform Fabrication *422*
16.4 Additive Prototyping Processes *422*
16.4.1 Stereolithography-Based Methods *422*
16.4.2 Flowable Powder Methods *423*
16.4.3 Ink Jet Methods *426*
16.4.4 Extrusion Methods *426*
16.5 Sheet-Based Processes *427*
16.6 Formative Prototyping Methods *427*
16.7 Casting Methods *428*
16.8 Plastic-Forming Methods *428*
16.9 Subtractive Methods *429*
16.9.1 Green (and Bisque) Machining *429*
16.10 Examples of SFF *429*
16.11 Summary *432*
References *432*

Part V Alternative Strategies to Ceramics *439*

17 Sintering of Nanograin Ceramics *441*
I.-Wei Chen and Xiaohui Wang
17.1 Introduction *441*
17.2 Background: What Went Wrong With Conventional Thinking? *442*
17.3 Two-Step Sintering of Y_2O_3 *445*
17.4 Two-Step Sintering of Other Ceramics *451*
17.5 Conclusions *453*
References *454*

18 Polymer-Derived Ceramics *457*
Emanuel Ionescu
18.1 Introduction *457*
18.2 Preceramic Polymers *457*
18.3 Polymer-to-Ceramic Transformation *459*
18.4 Processing Techniques for PDCs *462*
18.4.1 Polymer-Derived Ceramic Monoliths: Filler-Controlled Pyrolysis *462*
18.4.2 Polymer-Derived Ceramic Coatings *464*
18.4.3 Polymer-Derived Ceramic Fibers *466*
18.4.3.1 Silicon Carbonitride *467*
18.4.3.2 Silicon Borocarbonitride *467*
18.4.4 Polymer-Derived Ceramic Foams *468*
18.4.4.1 Direct-Foaming Techniques *468*
18.4.4.2 Infiltration of Porous Performs *469*
18.4.4.3 Sacrificial Fillers *469*
18.5 High-Temperature Behavior of PDCs *470*
18.5.1 Microstructure of PDCs *470*

18.5.2 Energetics in SiOC and SiCN Systems *472*
18.5.3 High-Temperature Stability of PDCs: Decomposition and Crystallization Processes *474*
18.5.4 Oxidation Behavior of PDCs *476*
18.6 Electrical Properties of PDCs *478*
18.6.1 Electrical Properties of SiOC-Based Ceramics *479*
18.6.2 Electrical Properties of SiCN-Based Ceramics *479*
18.7 Magnetic Properties of PDCs *481*
18.8 Polymer-Derived Ceramic Membranes *483*
18.9 Microfabrication of PDC-Based Components for MEMS Applications *485*
18.9.1 Direct Lithographic Methods *487*
18.9.2 Micromolding Techniques *489*
18.10 Summary and Outlook *491*
References *492*

19 High-Pressure Routes to Ceramics *501*
Dmytro A. Dzivenko and Ralf Riedel
19.1 Introduction *501*
19.2 Static High-Pressure Techniques *502*
19.2.1 Laser-Heated Diamond Anvil Cell (DAC) *503*
19.2.2 Multianvil Apparatus *506*
19.3 Shock-Wave Techniques *508*
19.4 Synthesis of Cubic Silicon Nitride *511*
References *513*

Index *519*